

INTERNATIONAL STANDARD



BASIC EMC PUBLICATION

**Electromagnetic compatibility (EMC) –
Part 4-23: Testing and measurement techniques – Test methods for protective
devices for HEMP and other radiated disturbances**



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ELECTROTECHNICAL
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CONTENTS

FOREWORD.....	6
INTRODUCTION.....	8
1 Scope.....	9
2 Normative references	9
3 Terms and definitions	10
4 HEMP test concepts	15
4.1 General.....	15
4.2 Testing of shielding enclosures	16
4.2.1 General	16
4.2.2 Buildings	19
4.2.3 Shelters and shielded rooms.....	20
4.2.4 Cabinets, racks and boxes.....	21
4.3 Testing of shielded cables and connectors.....	23
4.3.1 General	23
4.3.2 Testing of cable shields	23
4.3.3 Testing of cable connectors	26
4.4 Testing of shielding materials.....	27
4.4.1 General	27
4.4.2 Conducting gaskets	27
4.4.3 Conducting sheets and screens	29
4.4.4 Cut-off waveguides and honeycombs.....	32
4.5 Summary of test concepts.....	33
5 Test methods for measuring the shielding effectiveness of HEMP protection facilities.....	34
5.1 General.....	34
5.2 Electromagnetic field testing	34
5.2.1 General	34
5.2.2 Pulse field testing	34
5.2.3 CW field testing	40
5.3 Current injection test procedures	55
5.3.1 General	55
5.3.2 Injection testing of enclosures	55
5.3.3 Transfer impedance and admittance of cable shields and connectors	57
5.3.4 Testing of gasket material.....	57
Annex A (informative) HEMP test concepts for electrical systems	60
A.1 Overview.....	60
A.2 Types of HEMP tests	60
A.2.1 General	60
A.2.2 System-level transient tests	60
A.2.3 CW field illumination tests	61
A.2.4 Current injection testing.....	61
A.2.5 Partial illumination testing.....	62
A.2.6 Subsystem and component testing	62
A.3 Definition of the testing interface.....	63
A.4 Use of test data	65
A.4.1 General	65

A.4.2	Acceptance of new systems.....	65
A.4.3	System assessments	65
A.4.4	Hardness surveillance monitoring	65
A.4.5	System design.....	65
A.5	Testing uncertainties.....	66
Annex B (informative)	Characterization of shielded cables	67
B.1	Fundamentals of cable shielding	67
B.2	Definitions of transfer impedance and transfer admittance	68
B.3	Relative significance of Z'_t and Y'_t	71
Annex C (informative)	Equipment for HEMP pulse measurements.....	72
C.1	General.....	72
C.2	Sensors for HEMP measurements.....	72
C.2.1	<i>B</i> - and <i>H</i> -field sensors	72
C.2.2	<i>D</i> - and <i>E</i> -field sensors	74
C.2.3	Current sensors	76
C.3	Signal transmission.....	77
C.3.1	General	77
C.3.2	Fibre optic links	77
C.3.3	Fibre optic transducers	78
C.4	Signal detection and processing	78
Annex D (informative)	Equipment for CW testing	80
D.1	General.....	80
D.2	Antenna system	80
D.3	Power amplifier	82
D.4	Receiver (network analyser).....	83
D.5	Reference and response sensors.....	83
D.6	Fibre optic system.....	85
D.7	Limitations of measurements	88
Annex E (informative)	Characterization of a planar shield for HEMP protection.....	89
E.1	General.....	89
E.2	Problem geometry.....	90
E.3	Equivalent circuit representation	91
E.3.1	General	91
E.3.2	Chain parameter representation of the shield.....	92
E.3.3	Circuit responses.....	93
Annex F (informative)	Inside-to-out measurement method	97
F.1	Purpose	97
F.2	Comparison of existing SE test methods	97
F.3	Inside-to-out SE test of shielded rooms.....	98
F.3.1	Measurements of the inside-to-out SE	98
F.3.2	Summary	101
Bibliography.....		102

Figure 1 – Example of measured magnitude and phase of the transfer function $T(\omega) = H_{in}/H_{out}$ for a shielded enclosure

Figure 2 – Electric field and magnetic field shielding effectiveness of a 0,5 mm thick aluminum enclosure [29].....

Figure 3 – Measured magnetic field shielding effectiveness SE_H for a building.....

Figure 4 – Conceptual illustration of the HEMP test of a building	19
Figure 5 – Illustration of a shielded room or enclosure excited by HEMP fields	21
Figure 6 – Illustration of equipment racks, cabinets and box excited by internal HEMP disturbance.....	21
Figure 7 – A general shield excited by current injection	22
Figure 8 – Basic configuration for transfer impedance measurement.....	24
Figure 9 – Measured transfer impedance magnitude and phase of transfer impedance per unit length for four braided shield cables with good shielding properties	25
Figure 10 – Basic configuration for transfer admittance measurement.....	26
Figure 11 – Test configuration for transfer impedance measurement of a cable connector.....	26
Figure 12 – Examples of conducting gaskets used as HEMP protection devices	28
Figure 13 – Circuit model representing the behaviour of a conducting gasket for HEMP protection	28
Figure 14 – Measurement configuration for the resistivity of a sample.....	29
Figure 15 – Test concept for measuring the resistivity with surface probes	30
Figure 16 – Concepts for shielding effectiveness measurement of conducting sheets and screens	32
Figure 17 – Example of the calculated plane-wave shielding effectiveness of a 0,01 mm thick plate of different material as a function of frequency	32
Figure 18 – Cut-off waveguides and honeycomb used as protective elements.....	33
Figure 19 – Examples of full-scale, pulse-radiating HEMP simulators.....	37
Figure 20 – Test procedure for the pulse test.....	39
Figure 21 – Typical configuration of a CW test facility	40
Figure 22 – Example CW measurement set-up	41
Figure 23 – Test and analysis procedures for conducting a CW test.....	42
Figure 24 – Analysis flow diagram for extrapolating a measured CW spectrum to the HEMP response.....	43
Figure 25 – Example scan from 9 kHz to 3 GHz for the ambient electromagnetic field from communication signals.....	44
Figure 26 – Test procedure for the ambient EM excitation test	45
Figure 27 – Double-ended TEM cell for field illumination testing of small enclosures	46
Figure 28 – Example test set-up for field illumination in the TEM cell	47
Figure 29 – Illustration of the single-ended TEM cell and associated equipment	48
Figure 30 – Test set-up for the plane-wave shielding effectiveness measurements	50
Figure 31 – Test set-up for the <i>H</i> -field shielding effectiveness measurements.....	51
Figure 32 – Example of antenna locations for the localized antenna tests for a hypothetical shielded enclosure or facility	52
Figure 33 – Test concept and equipment configuration for current injection testing of a shielded enclosure or box	56
Figure 34 – Surface probe for volume resistivity measurement	59
Figure A.1 – Sample HEMP interaction diagram illustrating penetration mechanisms, system responses and generic test interface locations	64
Figure B.1 – Geometry of a shielded coaxial line with an internal circuit	67
Figure B.2 – Coaxial cable located over a conducting ground plane	68
Figure B.3 – Two per-unit-length circuits formed by the sheath and its ground return, and the sheath and the internal conductor	69

Figure C.1 – Magnetic field sensors [23]	73
Figure C.2 – Single-slot, cylindrical coil sensor [23]	73
Figure C.3 – Two- and four-slot cylindrical coil sensors [23].....	74
Figure C.4 – Electrical configuration of an E -field sensor [23]	74
Figure C.5 – Biconical E -field sensor	75
Figure C.6 – E -field sensor mounted on a conducting ground plane [23]	75
Figure C.7 – Equipotential shapes for an optimally designed E -field sensor [23]	75
Figure C.8 – Rogowski coil used for current measurements [23]	76
Figure C.9 – Toroidal current sensor made of magnetic material [23].....	76
Figure C.10 – Voltage pick-up points on the edges of the toroidal sensor [23].....	76
Figure C.11 – Example of a single-channel fibre optic transmission system [23]	77
Figure C.12 – Attenuation of coaxial lines and fibre optic cables as a function of frequency.....	78
Figure D.1 – Various antennas for CW testing.....	81
Figure D.2 – Relationship between the CW antenna and the incident HEMP field	82
Figure D.3 – Incident and ground-reflected field contributions to the reference sensor excitations	84
Figure D.4 – Measured reference H -field spectrum and its inverse Fourier transform	85
Figure D.5 – Measured sensor responses and calibration function	87
Figure D.6 – Measured transfer function, corrected by calibration file	87
Figure E.1 – Example of a general shielding problem.....	89
Figure E.2 – Behaviour of the impedance ratio EH as a function of distance from a source [29].....	90
Figure E.3 – Conducting slab of thickness, d , and infinite extent serving as an electromagnetic barrier	91
Figure E.4 – Equivalent circuit representation of the shielding problem	92
Figure E.5 – Two-port representation of a circuit.....	93
Figure F.1 – Test set-up for the outside-to-in and inside-to-out SE measurement.....	100
Table 1 – Recommended test procedure for different test objects	34
Table 2 – Dimensions and composition of distances d_1 to d_3 , with reference to Figure 30	50
Table 3 – Dimensions and composition of distances d_1 to d_3 , with reference to Figure 31	51
Table 4 – Measurement frequencies and antennas in plane-wave.....	52
Table 5 – Measurement frequencies and antennas in magnetic field.....	54
Table E.1 – Surface resistance and electrical parameters for selected materials.....	95
Table F.1 – Comparison with other standards	98
Table F.2 – Test shielded rooms	99
Table F.3 – Comparison of the SE measurement results.....	101

INTERNATIONAL ELECTROTECHNICAL COMMISSION

ELECTROMAGNETIC COMPATIBILITY (EMC) –

Part 4-23: Testing and measurement techniques – Test methods for protective devices for HEMP and other radiated disturbances

FOREWORD

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International Standard IEC 61000-4-23 has been prepared by subcommittee 77C: High power transient phenomena, of IEC technical committee 77: Electromagnetic compatibility.

It forms Part 4-23 of IEC 61000. It has the status of a basic EMC publication in accordance with IEC Guide 107.

This second edition cancels and replaces the first edition published in 2000. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) updates to the shielding effectiveness (SE) test method in Clause 5;
- b) a new Annex F describing methods for testing 'inside-to-out' has been added.

The text of this standard is based on the following documents:

CDV	Report on voting
77C/253/CDV	77C/257/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 61000 series, published under the general title *Electromagnetic compatibility (EMC)*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

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INTRODUCTION

IEC 61000 is published in separate parts, according to the following structure:

Part 1: General

General considerations (introduction, fundamental principles)

Definitions, terminology

Part 2: Environment

Description of the environment

Classification of the environment

Compatibility levels

Part 3: Limits

Emission limits

Immunity limits (in so far as they do not fall under the responsibility of the product committees)

Part 4: Testing and measurement techniques

Measurement techniques

Testing techniques

Part 5: Installation and mitigation guidelines

Installation guidelines

Mitigation methods and devices

Part 6: Generic Standards

Part 9: Miscellaneous

Each part is further subdivided into several parts, published either as international standards, as technical specifications or technical reports, some of which have already been published as sections. Others will be published with the part number followed by a dash and a second number identifying the subdivision (example: IEC 61000-6-1).

The IEC has initiated the preparation of standardized methods to protect civilian society from the effects of high power electromagnetic (HPEM) environments. Such effects could disrupt systems for communications, electric power, information technology, etc.

This part of IEC 61000 is an international standard that establishes the test concepts, set-ups, required equipment, and test procedures for protective devices against HEMP radiated disturbances.

Annex F provides examples of the SE test method placing the TX antenna inside the barrier.

ELECTROMAGNETIC COMPATIBILITY (EMC) –

Part 4-23: Testing and measurement techniques – Test methods for protective devices for HEMP and other radiated disturbances

1 Scope

This part of IEC 61000 provides a protective devices test method for HEMP and other radiated disturbances. It is primarily intended for HEMP testing but can be applied to other externally generated radiated disturbances where appropriate. It provides a brief description of the most important concepts for testing of shielding elements. For each test, the following basic information is provided:

- theoretical foundation of the test (the test concepts);
- test set-up including outside-to-in and inside-to-out measurements;
- required equipment;
- test procedures;
- data processing.

This international standard does not provide information on requirements for specific levels for testing.

This part of IEC 61000 has been updated to include a new test method.

Due to the available space, a transmitting antenna position outside the barrier has mainly been suggested. However, nowadays, many EMP protection facilities in practical use do not actually have enough space available outside the electromagnetic barrier due to physical constraints such as concrete walls or soil to allow the method described in IEC 61000-4-23:2000 (edition 1) to be applied correctly. From experience many facilities have available space for a 1 m separation or less only.

Therefore, in many practical cases it is not possible to measure shielding effectiveness according to the test method of previous documents. The constructors for EMP protection facilities are also unwilling to build facilities with extra space for measurements with the transmitting antenna outside the barrier due to the great expense and inefficiency of the operational working area for new or existing buildings.

This document provides additionally a method that allows the transmitting antenna to be placed inside the enclosure and the receiving antenna outside the barrier ('inside-to-out' method). Annex F includes test set-up and procedure examples.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60050-161, *International Electrotechnical Vocabulary (IEV) – Part 161: Electromagnetic compatibility* (available at www.electropedia.org)